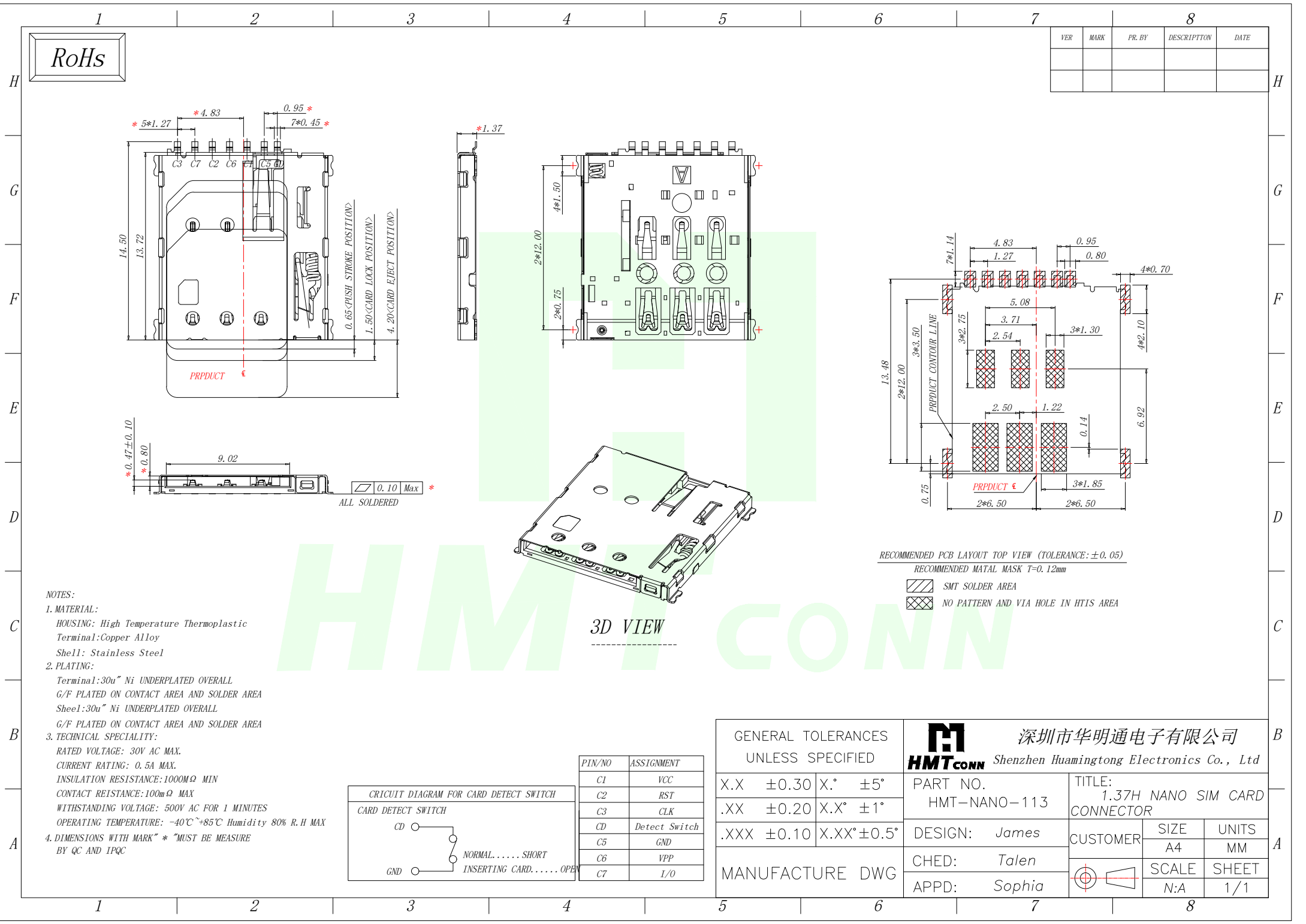




NOTES:

1. MATERIAL:

HOUSING: High Temperature Thermoplastic

Terminal: Copper Alloy

Shell: Stainless Steel

2. PLATING:

Terminal: 30u" Ni UNDERPLATED OVERALL

G/F PLATED ON CONTACT AREA AND SOLDER AREA

Shell: 30u" Ni UNDERPLATED OVERALL

G/F PLATED ON CONTACT AREA AND SOLDER AREA

3. TECHNICAL SPECIALITY:

RATED VOLTAGE: 30V AC MAX.

CURRENT RATING: 0.5A MAX.

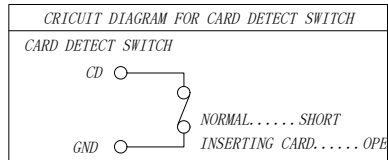
INSULATION RESISTANCE: 1000MΩ MIN

CONTACT RESISTANCE: 100mΩ MAX

WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTES

OPERATING TEMPERATURE: -40℃~+85℃ Humidity 80% R.H MAX

4. DIMENSIONS WITH MARK" * "MUST BE MEASURE
BY QC AND IPQC



PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
CD	Detect Switch
C5	GND
C6	VPP
C7	I/O

GENERAL TOLERANCES
UNLESS SPECIFIED

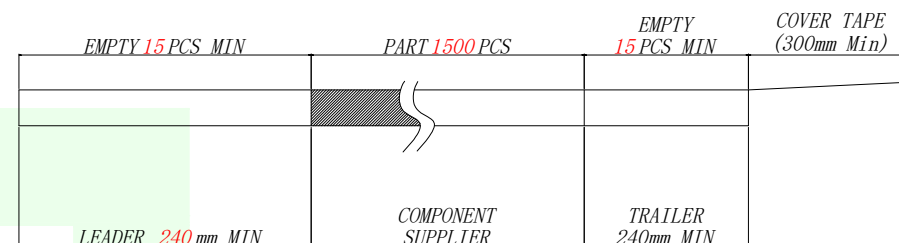
X.X	±0.30	X.*	±5°
.XX	±0.20	X.X*	±1°
.XXX	±0.10	X.XX*	±0.5°

MANUFACTURE DWG

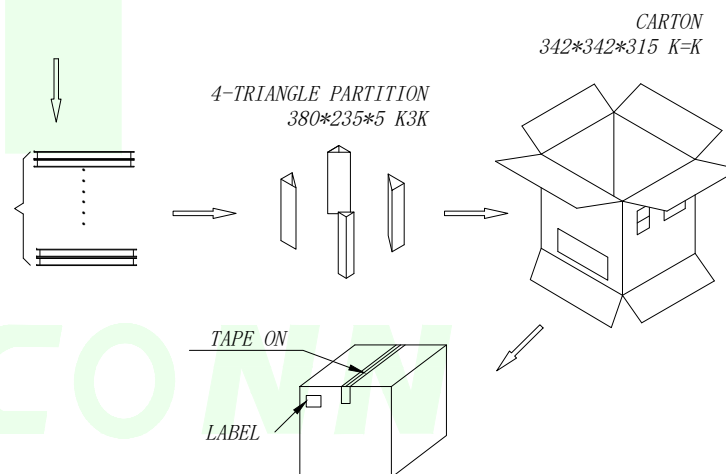
 HMT CONN 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd					
PART NO. HMT-NANO-113			TITLE: 1.37H NANO SIM CARD CONNECTOR		
DESIGN: James			SIZE A4	UNITS MM	
CHED: Talen			SCALE	SHEET	
APPD: Sophia			N:A	1/1	

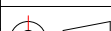
NOTES

1. NUMBER OF CONNECTORS: 1500 PCS/REEL
2. LEAD TAPE LENGTH



3. QUANTITY: 15000PCS/CARTON
4. WEIGHT :
3.1 NET WEIGHT : Kg
3.2 GROSS WEIGHT : Kg



GENERAL TOLERANCES UNLESS SPECIFIED		 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd			
X.X ±0.30	X.° ±5°	PART NO. HMT-NANO-113		TITLE: 1.37H NANO SIM CARD CONNECTOR	
.XX ±0.20	X.X° ±1°	DESIGN: James		CUSTOMER	SIZE
.XXX ±0.10	X.XX° ±0.5°	CHED: Talen			A4
MANUFACTURE DWG		APPD: Sophia			SCALE
					N:A
					UNITS
					MM
					SHEET
					1/1